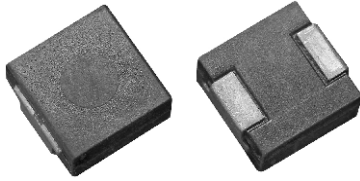


Molded, Low Profile, High Current Inductors



Manufactured under one or more of the following:
US Patents; 6,198,375/6,204,744/6,449,829/6,460,244.
 Several foreign patents, and other patents pending.

STANDARD ELECTRICAL SPECIFICATIONS				
L ₀ INDUCTANCE ± 20 % AT 100 kHz, 0.25 V, 0 A (μH)	DCR TYP. 25 °C (mΩ)	DCR MAX. 25 °C (mΩ)	HEAT RATING CURRENT DC TYP. (A) ⁽³⁾	SATURATION CURRENT DC TYP. (A) ⁽⁴⁾
0.10	1.5	1.7	32.5	60
0.15	1.9	2.5	26	52
0.20	2.4	3.0	24	41
0.22	2.5	2.8	23	40
0.33	3.5	3.9	20	30
0.47	4	4.2	17.5	26
0.68	5	5.5	15.5	25
0.82	6.7	8	13	24
1.0	9	10	11	22
1.5	14	15	9	18
2.2	18	20	8	14
3.3	28	30	6	13.5
4.7	37	40	5.5	10
6.8	54	60	4.5	8
8.2	64	68	4	7.5
10	102	105	3	7.0

Notes

- (1) All test data is referenced to 25 °C ambient
- (2) Operating temperature range - 55 °C to + 125 °C
- (3) DC current (A) that will cause an approximate ΔT of 40 °C
- (4) DC current (A) that will cause L₀ to drop approximately 20 %
- (5) The part temperature (ambient + temp rise) should not exceed 125 °C under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

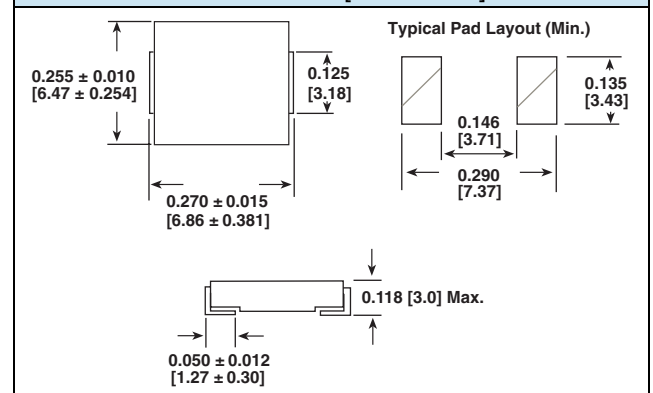
FEATURES

- Lowest molded height (3.0 mm) in this package footprint
- Shielded construction
- Frequency range up to 5.0 MHz
- Lowest DCR/μH, in this package size
- Handles high transient current spikes without saturation
- Ultra low buzz noise, due to composite construction
- Encapsulated body offers improved environmental protection and moisture resistance
- Higher dielectric withstanding voltage vs. IHLP
- Flame retardant encapsulant (UL 94 V-0)
- Corrosion resistant package
- Compliant to RoHS directive 2002/95/EC


RoHS
 COMPLIANT

APPLICATIONS

- PDA/notebook/desktop/server applications
- High current POL converters
- Low profile, high current power supplies
- Battery powered devices
- DC/DC converters in distributed power systems
- DC/DC converter for Field Programmable Gate Array (FPGA)
- Harsh environments including moisture, chemicals and salt spray

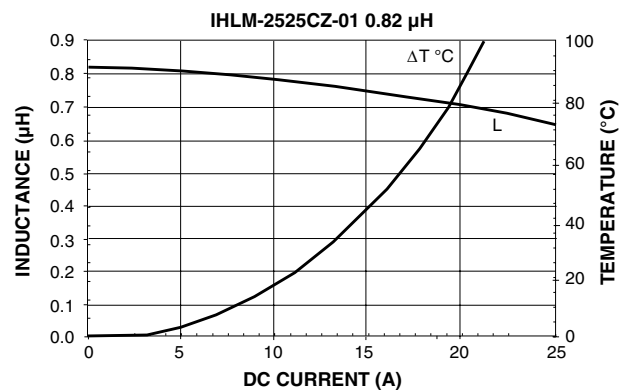
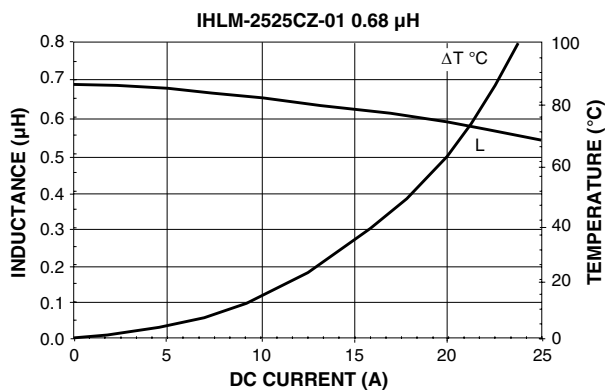
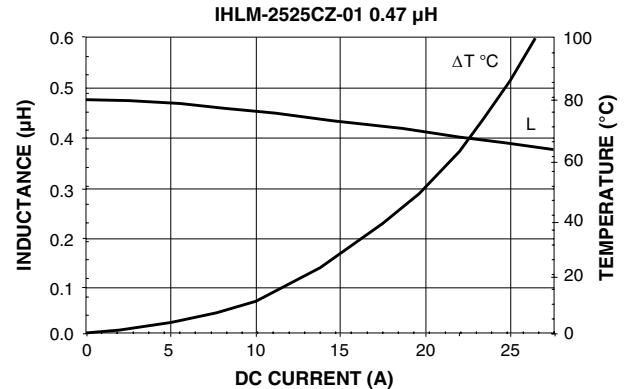
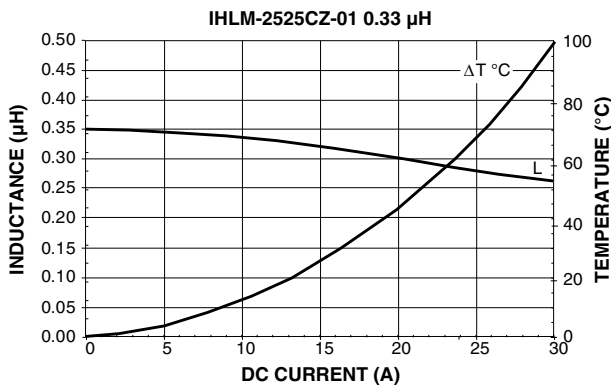
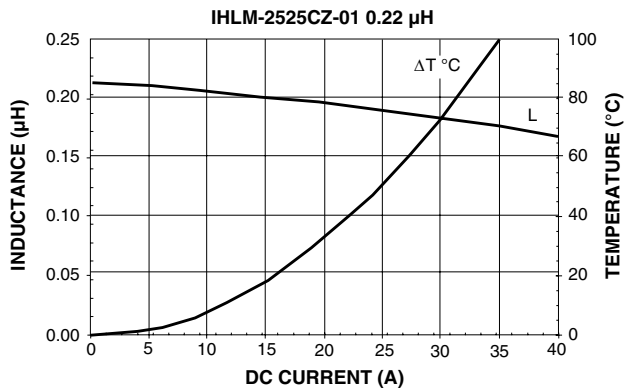
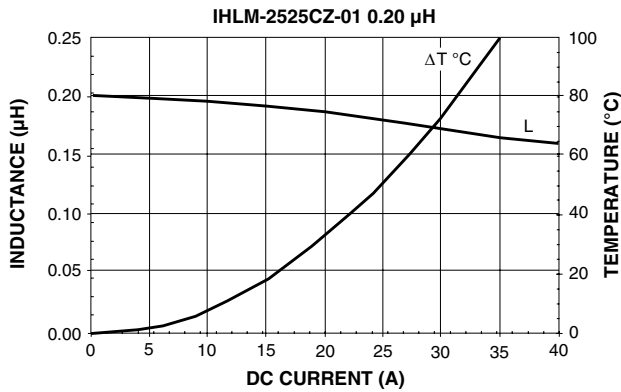
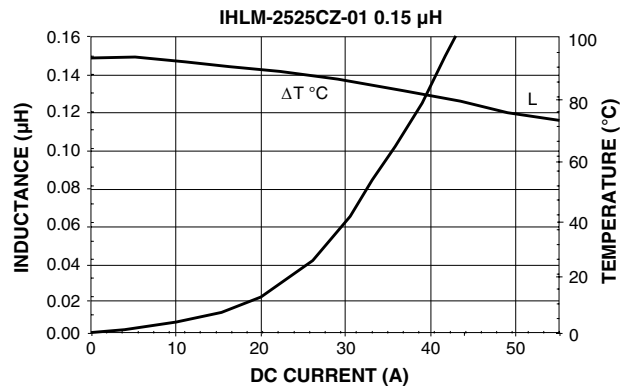
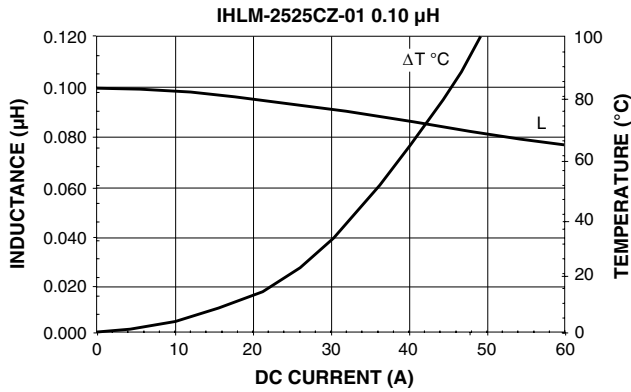
DIMENSIONS in inches [millimeters]

DESCRIPTION

IHLM-2525CZ-01	1.0 μH	± 20 %	ER	e3
MODEL	INDUCTANCE VALUE	INDUCTANCE TOLERANCE	PACKAGE CODE	JEDEC LEAD (Pb)-FREE STANDARD

GLOBAL PART NUMBER

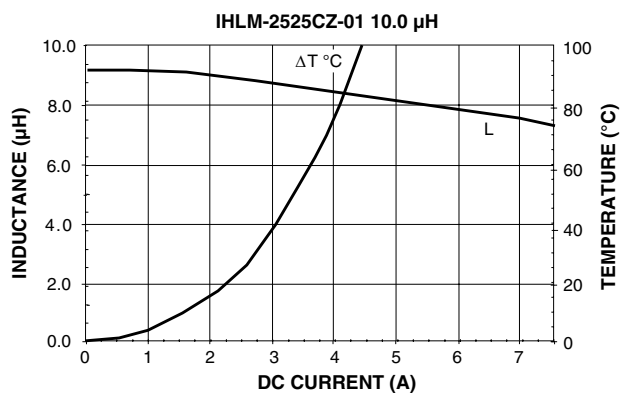
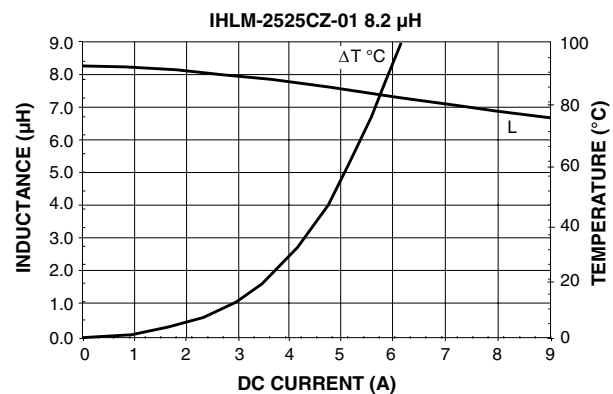
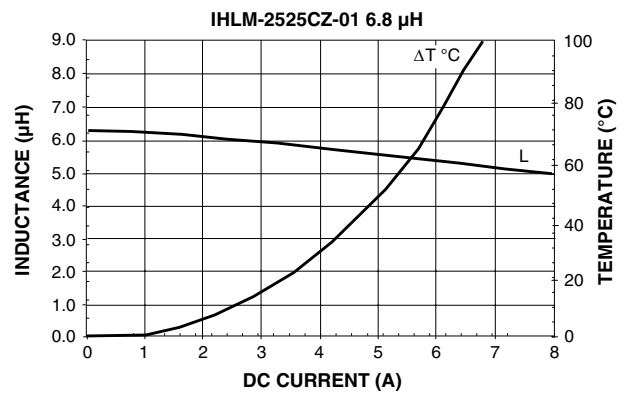
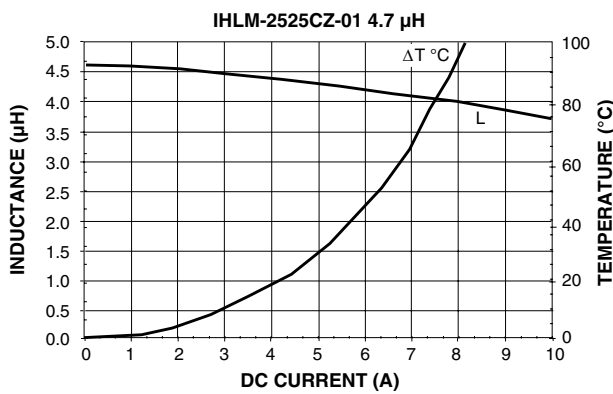
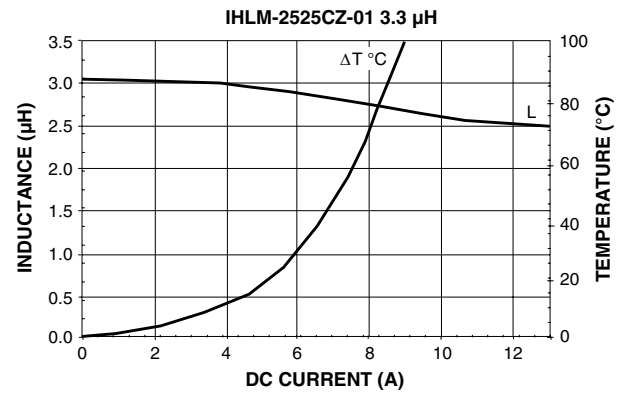
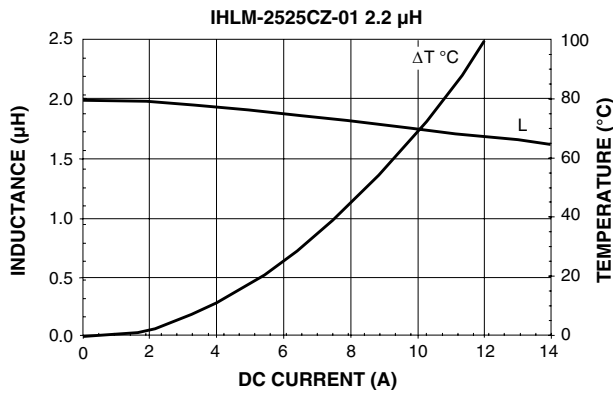
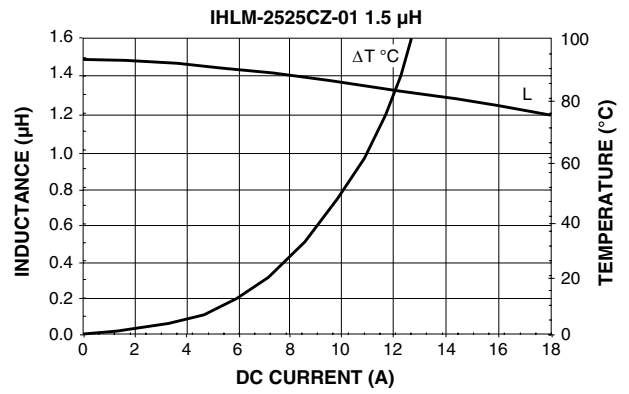
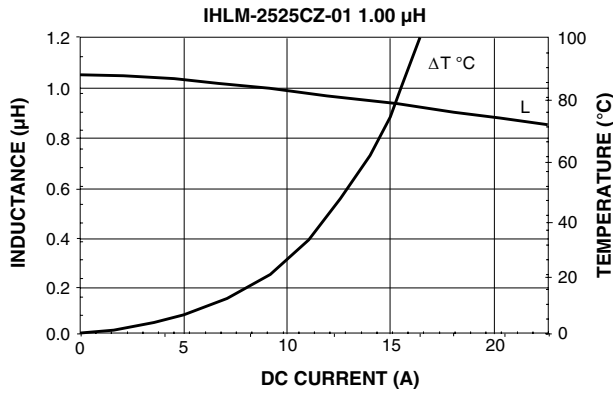
I	H	L	M	2	5	2	5	C	Z	E	R	1	R	0	M	0	1
PRODUCT FAMILY				SIZE						PACKAGE CODE		INDUCTANCE VALUE			TOL	SERIES	

PERFORMANCE GRAPHS





PERFORMANCE GRAPHS





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All product specifications and data are subject to change without notice.

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